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U.S. UTILITY Patent Application

PATENT NUMBER and
ISSUE DATE

APPL NUM 10024827	FILING DATE 12/17/2001	CLASS 257	SUBCLASS 670	GAU 2827 2841	EXAMINER LUAN THAI
**APPLICANTS: Yasunaga Shoshi; Hanada Hideshi; Ishibashi Takahiro; Sugimoto Jun; Dohki Yuichi; Etoh Hitoshi;					
**CONTINUING DATA VERIFIED:					
** FOREIGN APPLICATIONS VERIFIED: JAPAN P.2000-388711 12/21/2000					
PG-PUB <input type="checkbox"/> DO NOT PUBLISH <input type="checkbox"/> RESCIND <input type="checkbox"/>					
Foreign priority claimed <input type="checkbox"/> yes <input type="checkbox"/> no 35 USC 119 conditions met <input type="checkbox"/> yes <input type="checkbox"/> no Verified and Acknowledged Examiners's initials				ATTORNEY DOCKET NO 1488.00008	
TITLE : Lead frame for a semiconductor device, a semiconductor device made from the lead frame, and a method of making a semiconductor device					
U.S. DEPT. OF COMM./PAT & TM-PTO-436 (Rev. 12-94)					

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NOTICE OF ALLOWANCE MAILED		CLAIMS ALLOWED	
		Total Claims <input type="checkbox"/> Print Claim for O.G. <input type="checkbox"/>	
ISSUE FEE		DRAWING	
Amount Due	Date Paid	Sheets Drwg.	Figs. Drwg. <input type="checkbox"/> Print Fig. <input type="checkbox"/>
<input type="checkbox"/> TERMINAL DISCLAIMER		Application Examiner	
		PREPARED FOR ISSUE	
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